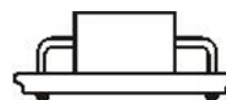


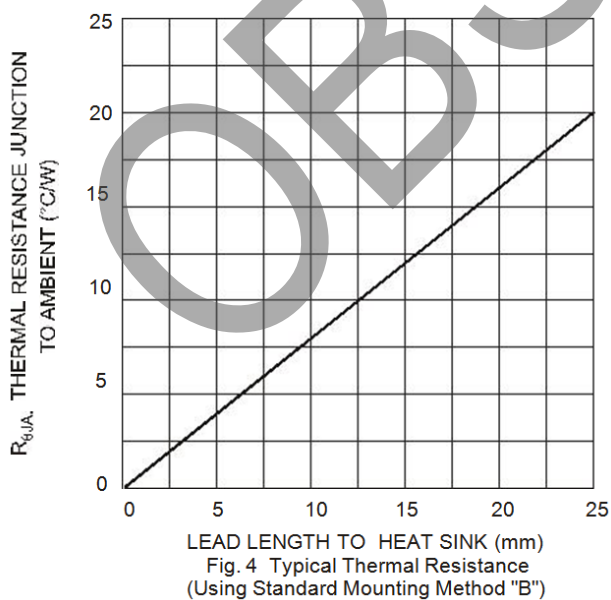
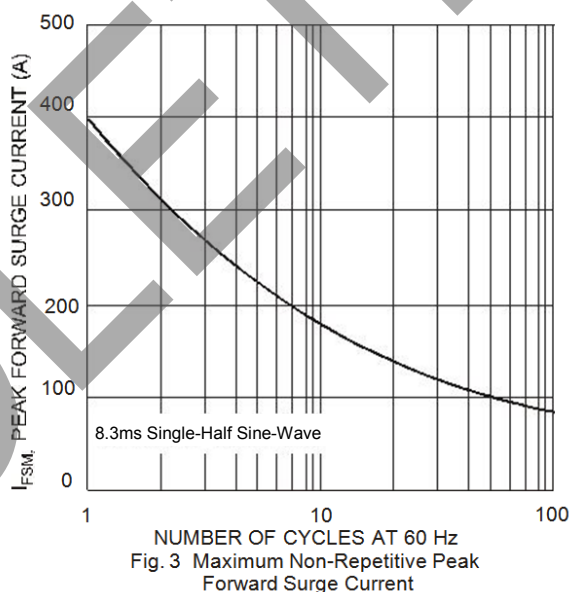
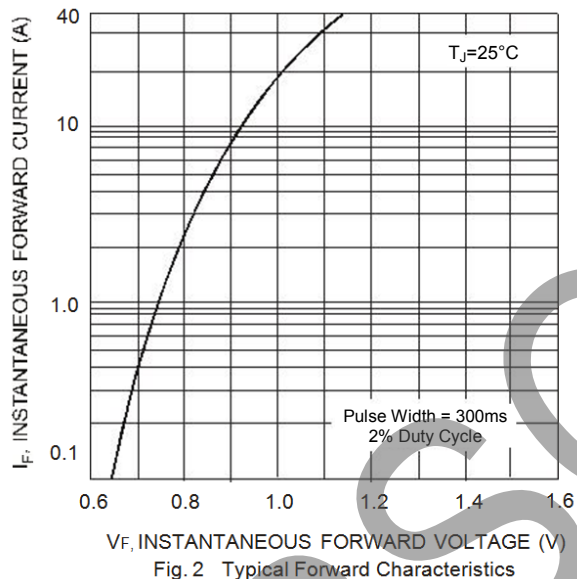
Recommended Method
(See Derating "A")



Standard Method
(See Derating "B")

Ground Plane: 25mm² equivalent
copper surface area

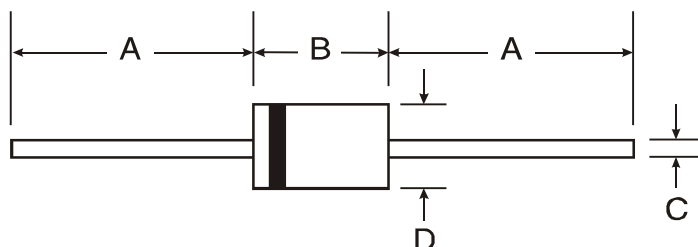
Printed Circuit Board Mounting Method



Package Outline Dimensions

Please see <http://www.diodes.com/package-outlines.html> for the latest version.

R-6



R-6		
Dim	Min	Max
A	25.40	-
B	8.60	9.10
C	1.20	1.30
D	8.60	9.10
All Dimensions in mm		

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